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Bib Data Sheet

SERIAL NUMBER 10/701,301	FILING DATE 11/03/2003 RULE	CLASS 438	GROUP ART UNIT 2812	ATTORNEY DOCKET NO. MI22-2438
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APPLICANTS

John T. Moore, Boise, ID;

** CONTINUING DATA ***** *AC*

This application is a CON of 09/602,381 06/22/2000 PAT 6,649,543 *AC*

** FOREIGN APPLICATIONS ***** *AC*

none

IF REQUIRED, FOREIGN FILING LICENSE GRANTED

** 02/12/2004

Foreign Priority claimed <input type="checkbox"/> yes <input checked="" type="checkbox"/> no	STATE OR COUNTRY ID	SHEETS DRAWING 4	TOTAL CLAIMS 17	INDEPENDENT CLAIMS 3
35 USC 119 (a-d) conditions met <input type="checkbox"/> yes <input checked="" type="checkbox"/> no <input type="checkbox"/> Met after Allowance	EXAMINER'S SIGNATURE <i>[Signature]</i>	INITIALS <i>[Initials]</i>		

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TITLE

Methods of forming dielectric materials and methods of processing semiconductor substrates

FILING FEE RECEIVED 770	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:	<input type="checkbox"/> All Fees <input type="checkbox"/> 1.16 Fees (Filing) <input type="checkbox"/> 1.17 Fees (Processing Ext. of time) <input type="checkbox"/> 1.18 Fees (Issue) <input type="checkbox"/> Other _____
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